2SD0875 (2SD875)

Silicon NPN epitaxial planar type

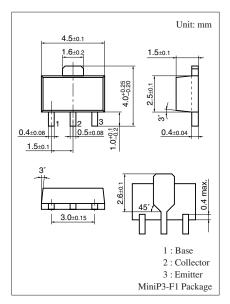
For low-frequency power amplification Complementary to 2SB0767 (2SB767)

Features

- \bullet Large collector power dissipation $P_{\rm C}$
- \bullet High collector-emitter voltage (Base open) $V_{\mbox{\scriptsize CEO}}$
- Mini power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

Absolute maximum riatings $T_a = 25$ C						
Parameter	Symbol	Rating	Unit			
Collector-base voltage (Emitter open)	V _{CBO}	80	V			
Collector-emitter voltage (Base open)	V _{CEO}	80	V			
Emitter-base voltage (Collector open)	V _{EBO}	5	V			
Collector current	I _C	0.5	А			
Peak collector current	I _{CP}	1	А			
Collector power dissipation *	P _C	1	W			
Junction temperature	Tj	150	°C			
Storage temperature	T _{stg}	-55 to +150	°C			

Absolute Maximum Ratings $T_a = 25^{\circ}C$



Marking symbol: X

Note) *: Printed circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{C} = 10 \ \mu A, \ I_{E} = 0$	80			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{C} = 100 \ \mu A, I_{B} = 0$	80			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_E = 10 \ \mu A, I_C = 0$	5			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 20 V, I_E = 0$			0.1	μΑ
Forward current transfer ratio	h _{FE1} *	$V_{CE} = 10 \text{ V}, I_{C} = 150 \text{ mA}$	130		330	
	h _{FE2}	$V_{CE} = 50 \text{ V}, I_{C} = 500 \text{ mA}$	50	100		
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 300 \text{ mA}, I_{\rm B} = 30 \text{ mA}$		0.2	0.4	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_{\rm C} = 300 \text{ mA}, I_{\rm B} = 30 \text{ mA}$		0.85	1.2	V
Transition frequency	f _T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		120		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		11	20	pF
(Common base, input open circuited)						

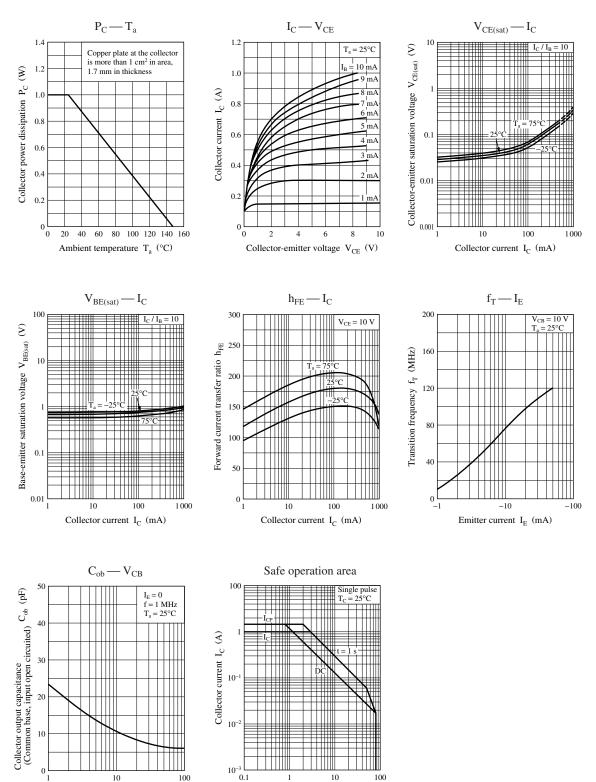
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Rank classification

Rank	R	S
h _{FE1}	130 to 220	185 to 330

Note) The part number in the parenthesis shows conventional part number.

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Collector-emitter voltage V_{CE} (V)

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